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COQUARD et al.(10) **Pub. No.: US 2025/0256865 A1**(43) **Pub. Date: Aug. 14, 2025**(54) **IMPROVED SYSTEM FOR THERMAL
REGULATION OF A SPACECRAFT**(30) **Foreign Application Priority Data**

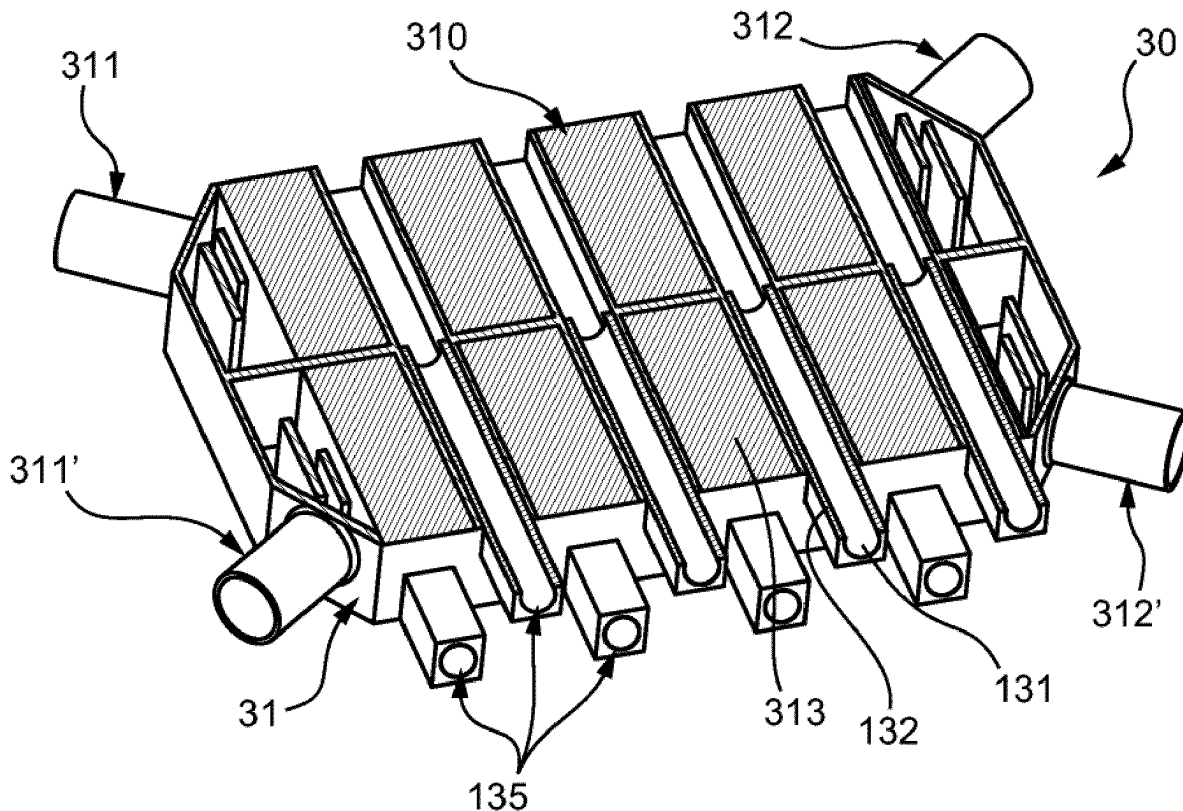
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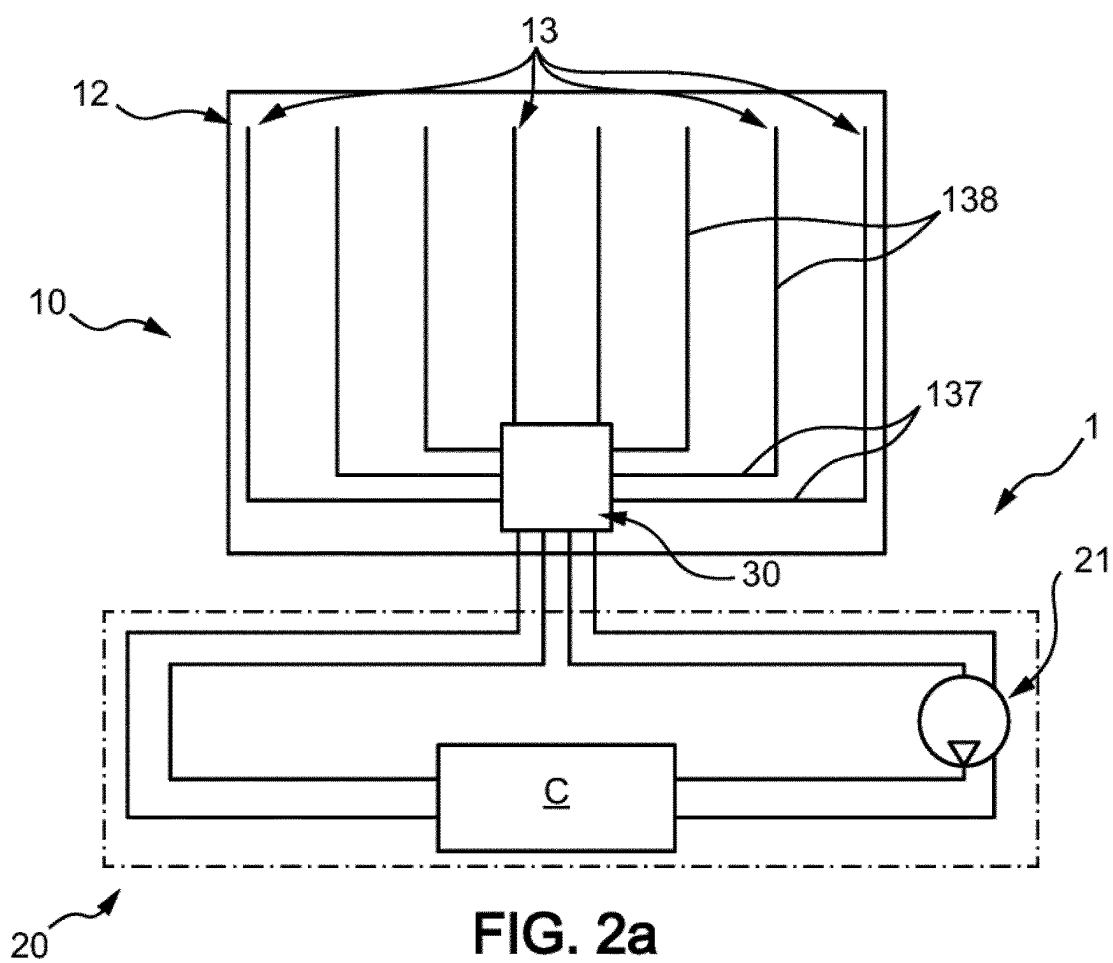
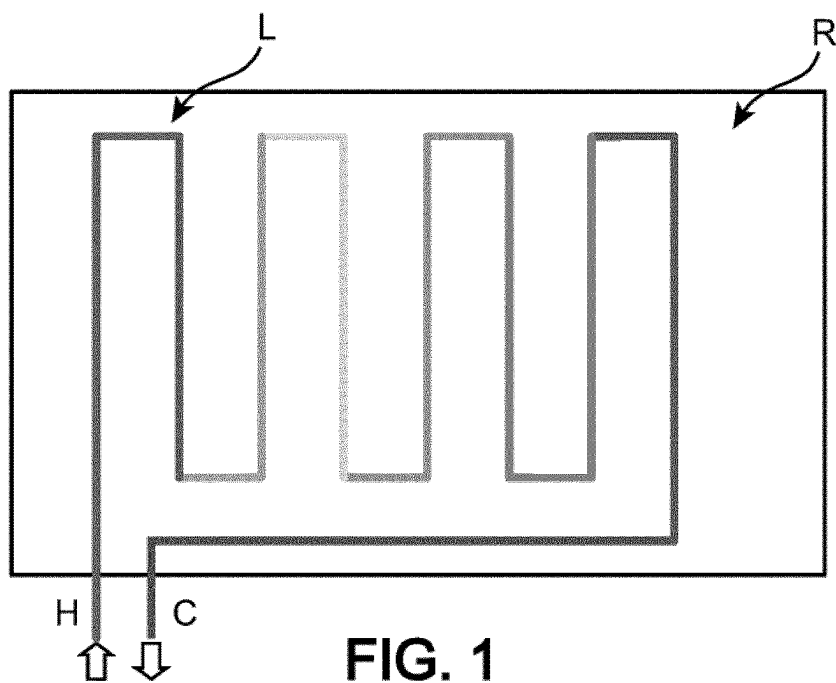
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MOSSEVELD, Toulouse Cedex 4 (FR)(57) **ABSTRACT**

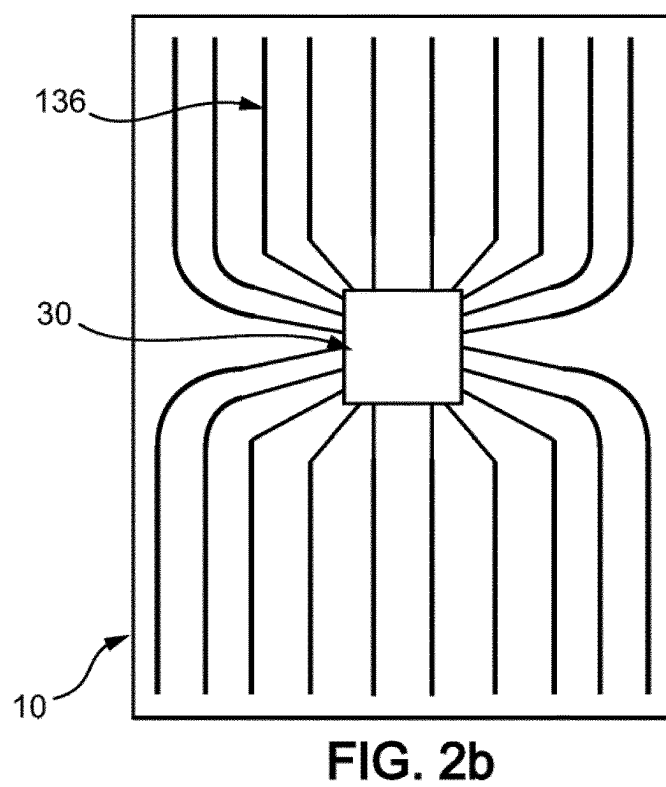
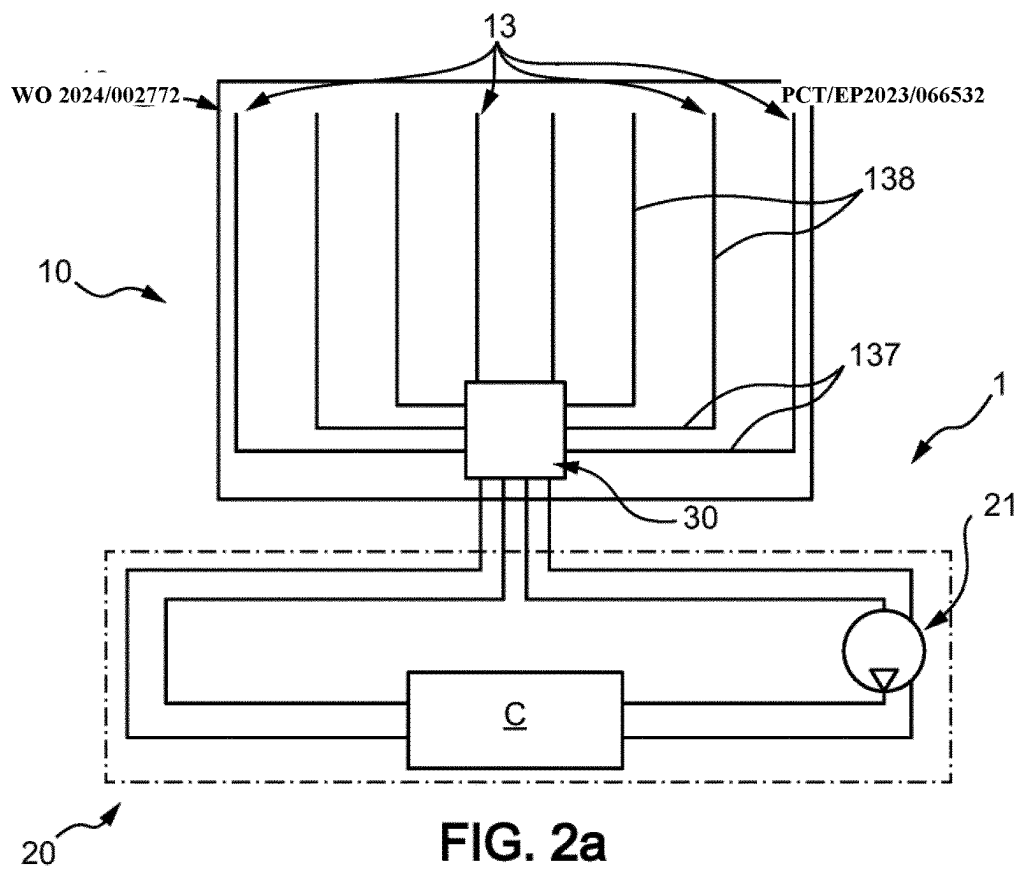
A system for thermal regulation of a spacecraft is disclosed including a radiator having a thermally conductive body including at least one radiative surface, at least one diphasic duct extending along the body and in thermal contact with the body. The system includes at least one single-phase cooling fluid circuit and a heat exchange device assembled to the body, the heat exchange device includes a casing having at least an internal cavity having input and output ports for connection with said single-phase cooling fluid circuit, and in that the casing further integrates a first section of each diphasic duct, each section being in thermal contact with the internal cavity.

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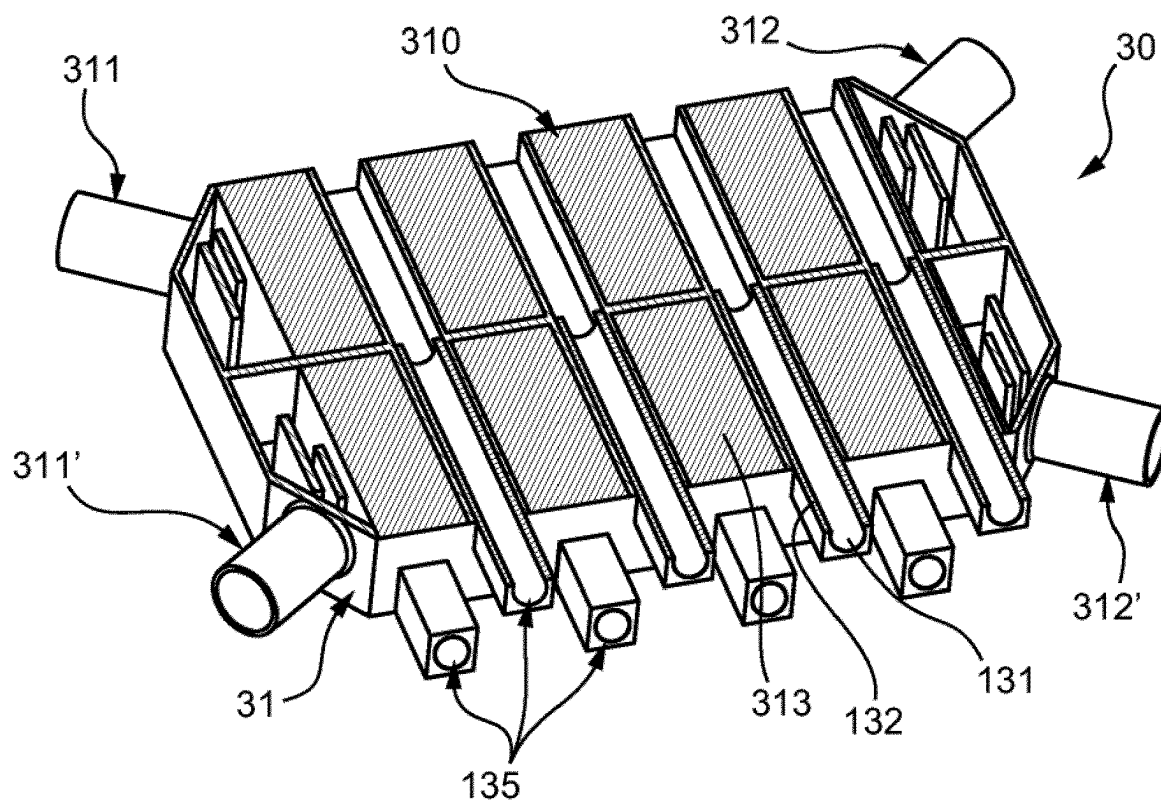


FIG. 3b

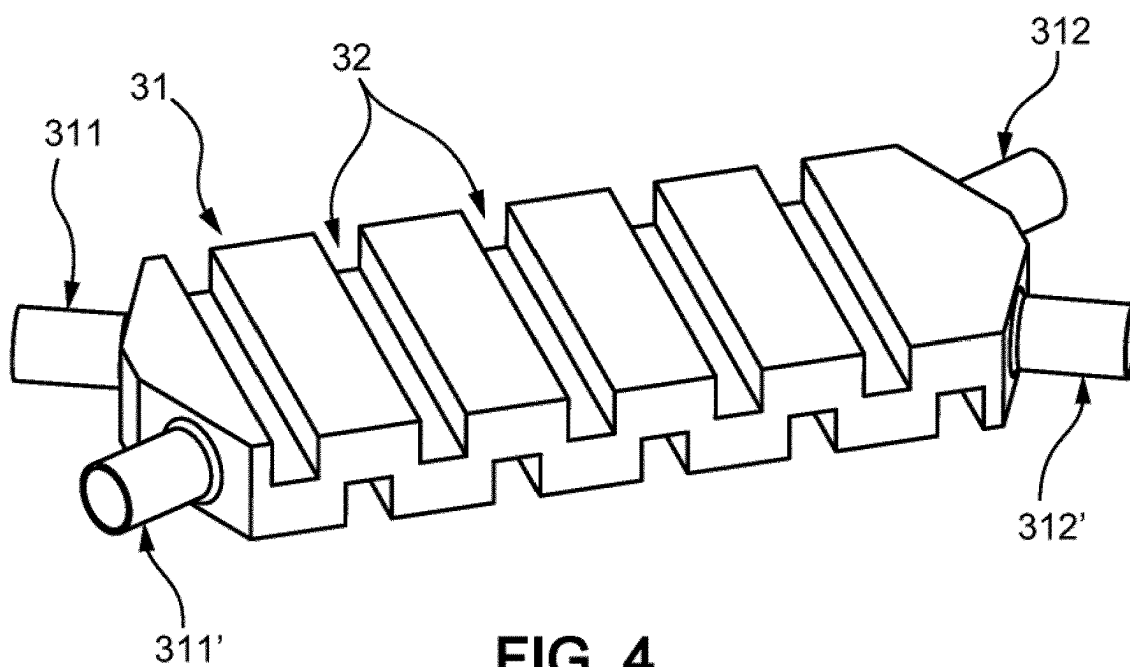


FIG. 4

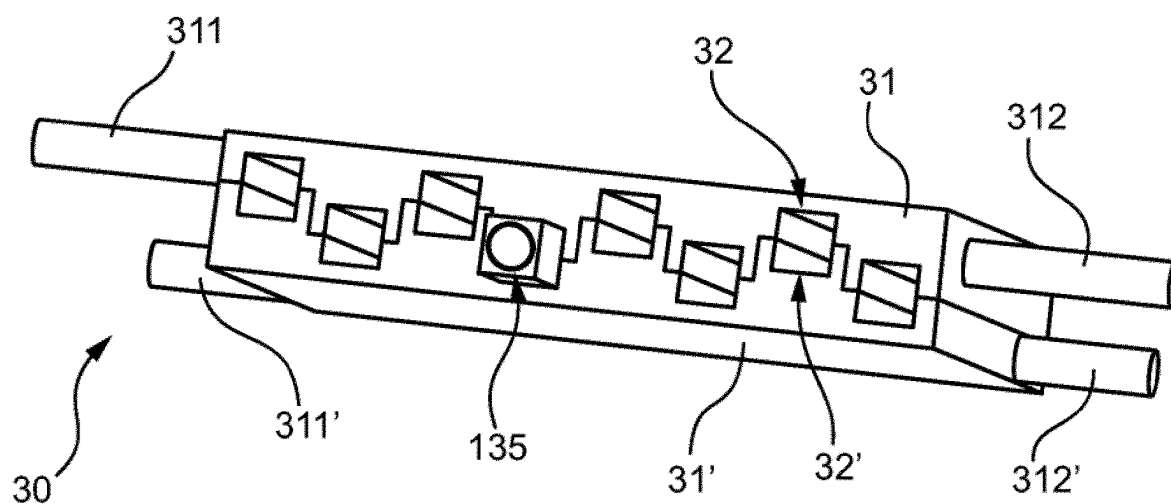


FIG. 5

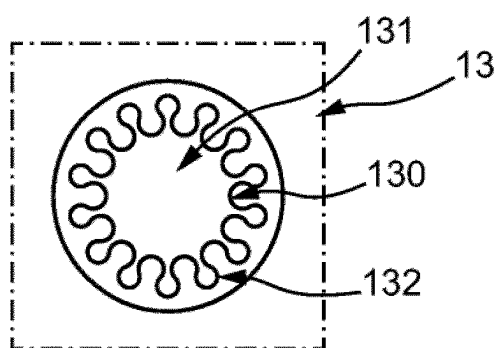


FIG. 6

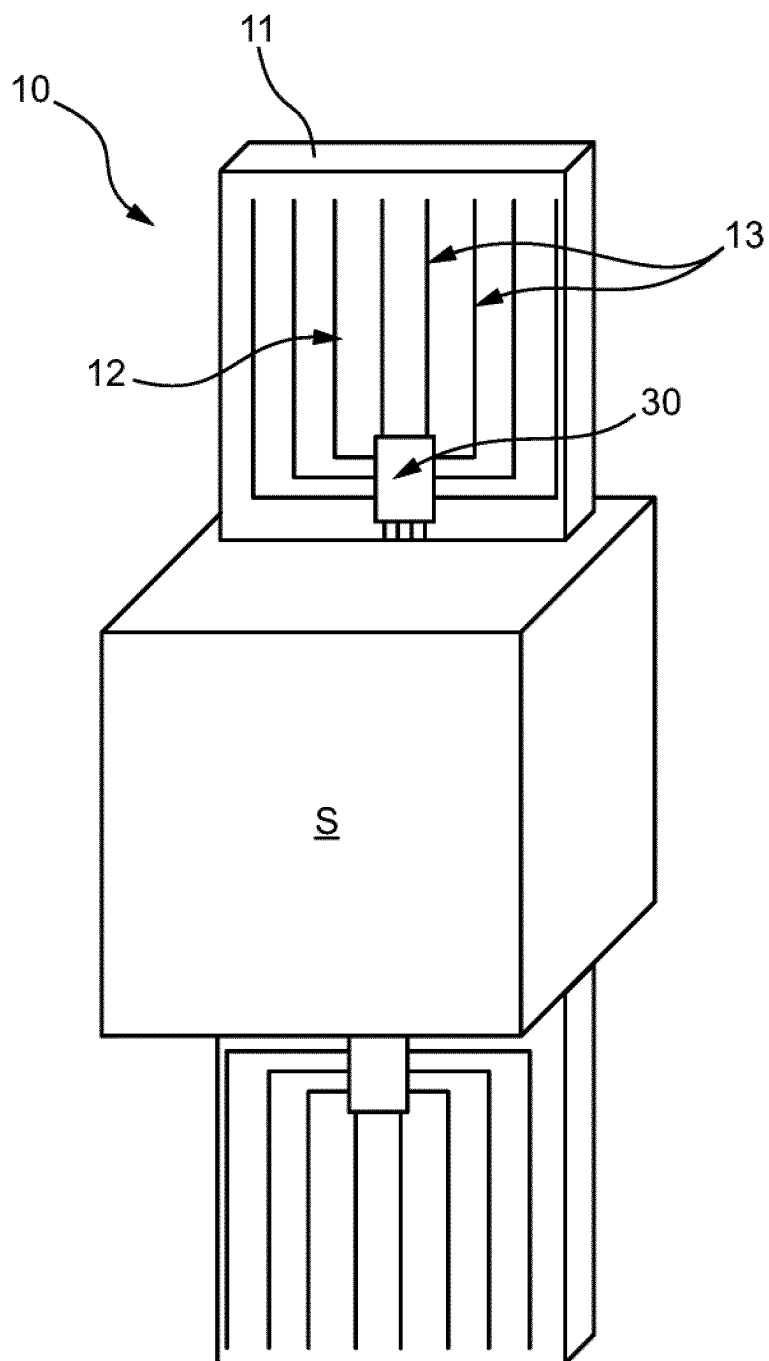


FIG. 7

IMPROVED SYSTEM FOR THERMAL REGULATION OF A SPACECRAFT

TECHNICAL FIELD

[0001] The present disclosure relates to a system for thermal regulation of a spacecraft, and a spacecraft comprising such system.

STATE OF THE ART

[0002] A spacecraft usually carries a payload comprising electronic devices dedicated to perform various functionalities such as measurements, controls, communication etc. These electronic devices produce heat which must be dissipated in order to prevent excessive heating and degradation of the devices.

[0003] It is conventional to achieve the rejection of the heat produced by the payload of the spacecraft by radiation to the deep space. To this end, a conventional thermal regulation system can comprise a radiator of a spacecraft, and a fluid circuit in which a cooling fluid circulates, the fluid circuit being arranged to collect heat from one or several heat-producing component(s) and to bring the collected heat to the radiator. The fluid circuit may comprise a pump for circulating the cooling fluid.

[0004] With reference to FIG. 1 is schematically shown a conventional design of a radiator R along which extends a line L of the fluid circuit comprising the cooling fluid. The cooling fluid circulates within the cooling line and enters at a relatively high temperature H and exits at a cooler temperature C. Conventionally, a single cooling line is embedded or mounted at the surface of the radiator, according to a pattern that covers the whole surface of the radiator. As the cooling line is in thermal contact with the radiator, this pattern increases the surface of thermal exchange between the cooling line and the radiator, and improves the cooling. However, such pattern also leads to a significant surface of the cooling line being exposed to the external environment, increasing the risk of being hit by micrometeoroid and debris, and lowering the overall reliability and service life of the cooling system, rendering it improper for very long missions.

[0005] It is also known from FR 2 972 714 another system for thermal regulation of a spacecraft, comprising a structural panel of a satellite having an outer skin that is configured to radiate heat and an inner skin on which are mounted a plurality of heat-generating components. The system for thermal regulation further comprises a cooling circuit comprising an evaporator line running along the inner skin of the panel, and configured to receive heat from the heat-generating components, and a plurality of condensers on the outer skin of the panel, each condenser transferring heat to the outer skin of the panel via a respective heat pipe with which it is in thermal contact.

[0006] The system actually comprises two parallel lines of condensers, the two parallel lines being in fluid communication, such that a damage caused by a debris or a micrometeoroid on one condenser or one conduit linking two adjacent condensers may result in a leakage of the whole line, and failure of the whole thermal regulation device.

[0007] In this regard, document FR 2 972 714 further teaches to protect the condensers from micrometeoroids by hardening the walls of the condensers and of the conduits linking adjacent condensers.

[0008] This system is however complex and costly due to the complexity of the cooling fluid circuit and the important number of condensers.

PRESENTATION OF THE INVENTION

[0009] In view of the above, the present disclosure aims at providing a system for thermal regulation of a spacecraft that reduces the risks caused by debris of micrometeoroids on operation of the system.

[0010] Another aim of the present disclosure is to provide a system that is cheaper and of simpler design than the prior art.

[0011] Accordingly, a system for thermal regulation of a spacecraft is disclosed, comprising:

[0012] a hot source interface,

[0013] a radiator having a thermally conductive body comprising at least one radiative surface,

[0014] two separate single-phase cooling fluid circuits (20) arranged in or on said hot source interface, each single-phase cooling circuit comprising a pump for activating the circulation of the single-phase cooling fluid,

the system further comprising a heat exchange device arranged in or on the body of the radiator, the heat exchange device comprising a casing comprising at least two internal cavities each having input and output ports for separately connecting each of said single-phase cooling fluid circuit to the heat exchange device,

and wherein the heat exchange device (30) comprises a plurality of thermal interfaces with a plurality of diphasic ducts (13), the diphasic ducts being separate from each other and separate from the single-phase cooling fluid circuits (20), the diphasic ducts (13) being arranged around the heat exchange device (30), each diphasic duct extending at least from a first section (135) of said diphasic duct to a second section (136) of said diphasic duct, said first (135) section being arranged on one of said thermal interfaces of the heat exchange device and said second section (136) of said diphasic duct being arranged in or on said body of said radiator (10), the second sections of the diphasic ducts extending around the heat exchange device.

[0015] In embodiments, the first section of each diphasic duct extends along a direction transverse to the direction of said single-phase cooling fluid circuit in the internal cavities and the internal cavities are shaped such that the cooling fluid circulating within the cavities circulates around at least part of the circumference of each duct section.

[0016] In embodiments, the first sections of the diphasic ducts comprise at least two superposed layers of first duct sections, wherein the first duct sections of a layer are offset relative to the duct sections of an adjacent layer, and the internal cavities circulate between the first duct sections of two adjacent layers.

[0017] In embodiments, the first diphasic ducts sections extend parallel to each other, and the second duct sections extend in different directions in a plane parallel to the radiative surface.

[0018] In embodiments, each of said internal cavities comprises an internal lattice structure disposed transversally to an internal circuit joining said input and output ports and linked to said thermal interfaces.

[0019] In embodiments, the internal cavities are formed by walls of a thermally conductive material, and the internal lattice is formed of a thermally conductive material.

[0020] In embodiments, the first diphasic duct section of each diphasic duct forms an end of the diphasic duct.

[0021] In embodiments, the casing comprising the cavities and the first diphasic duct sections is formed as a single piece manufactured by additive manufacturing, and each first duct section is assembled to a second duct section extending from the casing.

[0022] In embodiments, each first diphasic duct section protrudes from a wall of the casing delimiting the internal cavities, and is assembled to a second diphasic duct section in order to form a respective diphasic duct, said assembly being achieved by welding, brazing, or by a shape-memory fitting.

[0023] In embodiments, the casing comprises a plurality of open grooves configured to receive a corresponding first diphasic duct section.

[0024] In embodiments, each first diphasic duct section is inserted in a corresponding open groove and assembled to it by thermal glue, welding or brazing.

[0025] In embodiments, each first diphasic duct section has the same thermal exchange surface with both internal cavities.

[0026] In embodiments, the system comprises two casings each comprising one of

[0027] the internal cavities, each casing comprising a plurality of open grooves configured each to receive a corresponding first diphasic duct section, and the two casings are assembled together with the open grooves of a casing facing the open grooves of the other casing.

[0028] In embodiments, each diphasic duct comprises at least one internal canal for vapor circulation and a capillary structure for liquid circulation.

[0029] According to another aspect, it is disclosed a spacecraft comprising at least one heat-producing component and a system for thermal regulation according to the above description.

[0030] The system according to the present disclosure comprises a single heat exchange device assembled to the body of a radiator of the spacecraft, the heat exchange device comprising a body having an internal cavity for circulation of a single-phase cooling fluid, and a section of each diphasic duct running along the surface of the radiator, each section being in thermal contact with the internal cavity.

[0031] The design of the system is simple since it does not rely on a phase-changing cooling fluid.

[0032] Moreover, the heat exchange device may distribute heat of the cooling fluid to a plurality of independent diphasic ducts, running along the surface of the radiator. Thus, as the distribution of heat produced by the spacecraft components is distributed to the diphasic ducts by means of a single and compact heat exchange device, the probability of such device being hit by a debris or micrometeoroid and causing failure of the system is reduced.

[0033] When the internal cavities comprise an internal lattice structure, the liquid is slowed down and the thermal conductivity with the diphasic ducts is enhanced.

DESCRIPTION OF THE DRAWINGS

[0034] Other features and advantages of the invention will be apparent from the following detailed description given by way of non-limiting example, with reference to the accompanying drawings, in which:

[0035] FIG. 1, already discussed, schematically represents an example of a spacecraft radiator according to the prior art,

[0036] FIG. 2a schematically represents an example of a system for thermal regulation of a spacecraft according to an embodiment,

[0037] FIG. 2b schematically represents an alternative configuration of a radiator on which a heat exchange device is mounted,

[0038] FIGS. 3a and 3b respectively show an external and internal view of a heat exchange device according to a first embodiment,

[0039] FIG. 4 shows an external view of a heat exchange device according to a second embodiment,

[0040] FIG. 5 shows an external view of a heat exchange device according to a third embodiment.

[0041] FIG. 6 shows an exemplary cross section of a heat-pipe.

[0042] FIG. 7 schematically represents an example of a spacecraft comprising a system for thermal regulation according to an embodiment.

DETAILED DESCRIPTION OF AT LEAST ONE EMBODIMENT

[0043] With reference to the appended figures, a system for thermal regulation of a spacecraft will now be described. With reference to FIG. 7, the spacecraft S may be a satellite, for instance a LEO, MEO or GEO satellite, including a so-called nanosatellite, minisatellite or any other constellation platform. Alternatively, the spacecraft may also be a space station or a probe embarking instruments.

[0044] With reference to FIG. 2a, the system 1 for thermal regulation of a spacecraft comprises at least one radiator 10, having a thermally conductive body 11 comprising at least one radiative surface 12. The thermally conductive body may be formed in metal or in a metallic alloy, for instance an aluminum alloy. The radiative surface may be a coating of the thermally conductive body, for instance white paint, an optical solar reflector, etc.

[0045] In embodiments, the radiator 10 may form a structural panel of the spacecraft, having an outer skin oriented towards outer space and an inner skin oriented towards the inside of the spacecraft. The structural panel may further comprise an internal structure supporting the inner and outer skins, for instance a honeycomb structure. The inner and outer skin may for instance comprise a layer of metal or metallic alloy, for instance an aluminum alloy. In this case, the radiative surface 12 of the radiator 10 corresponds to the outer skin of the structural panel. In other embodiments, the radiator 10 may be an appendix of the spacecraft that is either in fixed position, or deployable, relative to the spacecraft's structure.

[0046] The system 1 for thermal regulation further comprises at least one diphasic duct 13 extending along the body 11 of the radiator, in thermal contact with said body, so as to transfer heat to the radiative surface 12. In embodiments, the system comprises a plurality of diphasic ducts 13, which may be independent, i.e. devoid of any fluid connection between them.

[0047] A diphasic duct could be, for example, in the form of heat pipe or a loop heat pipe. A diphasic duct is for example a conduit having an interactive flow of two distinct phases (gas and liquid) with common interfaces. A diphasic duct is notably a section of tube or piping which contains or facilitates the transfer of fluid and/or Gas. A heat pipe is for

example a diphasic duct having a hot source and a cold source and counter flows of gas and liquid phases. A heat pipe is notably a tube which is used to encourage the transport heat between two locations, usually with (but not restricted to) an internal fluid and/or gas.

[0048] As shown schematically in FIG. 6, representing an example of a transverse cross-section of a diphasic duct 13, each diphasic duct may comprise an internal cavity 130 comprising a diphasic fluid in a liquid-vapor equilibrium. The internal cavity may comprise at least one internal canal 131 for the circulation of the fluid in vapor phase and a capillary structure 132 enabling the circulation of fluid in liquid phase.

[0049] The diphasic ducts 13 may either be embedded within the body 11 of the radiator, in thermal contact with the radiative surface, or mounted on the radiative surface 12.

[0050] Back to FIG. 2a, the system 1 for thermal regulation of the spacecraft further

[0051] comprises a cooling fluid circuit 20 extending between at least one heat-producing component C of the spacecraft and the radiator. As schematically shown in FIG. 2, the cooling fluid circuit 20 may comprise a pump 21 for circulating cooling fluid within the circuit. In preferred embodiments, the cooling fluid circuit is single phase, i.e. the cooling fluid being is in liquid state or in vapor state in the circuit, and does not undergo any phase change within the circuit. The cooling fluid may for instance be water (high purity deionized water), ammonia, gaseous helium, gaseous nitrogen, propylene, isopropyl alcohol, polypropylene glycol etc.

[0052] In embodiments, and as schematically shown in FIG. 2a, the system 1 for thermal regulation of the spacecraft may be redundant, i.e. it may comprise a pair of said single-phase cooling fluid circuits, arranged to receive heat from the same heat-producing component(s), the cooling fluid circuits being devoid of any fluid communication with one another.

[0053] The system 1 further comprises a heat exchange device 30, which is assembled to the radiator's body 11 and may be embedded within the radiator's body 11 or mounted on the radiative surface 12. The heat exchange device 30 comprising a casing 31, having an internal cavity 310 comprising input 311 and output ports 312 for connecting with the single-phase cooling circuit. In operation, the cooling fluid of the single-phase cooling circuit thus circulates within the cavity from an input port 311 to an output port 312 and is then circulated back towards the heat-producing components.

[0054] The casing 31 of the heat exchange device 30 also integrates a first section 135 of each diphasic duct 13, each first section 135 of diphasic duct being in thermal contact with the internal cavity 310 of the casing and hence with the cooling fluid circulating within the cavity. To this end, the casing 31 of the heat exchange device and each diphasic duct section 135 may be formed in a thermally conductive material, for instance in a metal or metallic alloy, for instance an aluminum alloy. Moreover, and as shown for instance in FIG. 3b, the internal cavity 310 of the casing may comprise an internal lattice, such as a plurality of internal fins 313 formed of a thermally conductive material. The internal lattice is disposed transversally to the direction of the cooling fluid. The cooling fluid thus circulates inside the cavity between the internal fins, which slows down the

circulation of the cooling fluid and increases the thermal exchange surface between the fluid and the casing.

[0055] In embodiments, each diphasic duct 13 comprises at least one first section 135 integrated in the casing 31 of the heat exchange device, and at least one second section 136 extending from said casing, the first and second sections of a diphasic duct being assembled together. The first section 135 of each diphasic duct integrated in the casing of the heat exchange device may be an end portion of said diphasic duct. Each section 135, 136 thus comprises at least one internal canal for the circulation of fluid in vapor phase and a capillary structure for the circulation of fluid in liquid phase, and the sections 135, 136 are aligned to ensure communication of the vapor canals of the sections and of the capillary structures of the sections.

[0056] When the system comprises a plurality of independent diphasic ducts 13 extending along the body of the radiator, the heat exchange device 30 comprises a first section 135 of each diphasic duct 13, all of these sections being in thermal contact with the internal cavity 310. Thus, the heat exchange device 30 forms a single location for heat exchange between the cooling fluid circuit and the diphasic ducts distributed along the radiator's body, thereby enabling compact transfer of heat. Furthermore, in that case the risk caused by a micrometeoroid impact on a diphasic duct is limited by the ducts being all independent, since the diphasic duct can be damaged without causing failure to the other diphasic ducts of the regulation system.

[0057] When the system for thermal regulation is redundant, the casing 31 of the heat exchange device comprises one input port 311, 311' and one output port 312, 312' respectively connected to each single-phase cooling circuit, and two internal cavities which are leak-tightly separated from each other. In that case, the surfaces of thermal exchange between a first diphasic duct section 135 and each one of the two cavities are preferably equal.

[0058] With reference to FIG. 2a, the operation of the thermal regulation system is thus as follows:

[0059] the cooling fluid circulating within the cooling circuit heats up when collecting heat at the heat-producing component C and circulated towards the heat exchange device,

[0060] at the internal cavity of the heat exchange device, the heat brought by the cooling fluid is transferred to first the diphasic duct sections 135 integrated to the casing, and the dual-phase fluid located inside the diphasic ducts is evaporated. Said first diphasic duct sections 135 thus form an evaporator section of the diphasic ducts.

[0061] the heat is then transferred to the radiative surface of the radiator and radiated towards space, via the second diphasic duct sections extending along the radiator's body. The fluid in vapor state of the diphasic ducts is condensed, and thus said second diphasic duct sections form condenser sections of the diphasic ducts.

[0062] The cooling fluid of the single-phase cooling circuit exits the heat exchange device at a lower temperature and is then circulated back towards the heat-producing component.

[0063] The first diphasic ducts sections 135 integrated in the casing of the heat exchange device may extend parallel to one another, and may be arranged in one plane, or in a plurality of superposed planes.

[0064] The second diphasic ducts sections **136** extending from the heat exchange device, along the radiator's body, may be disposed in order to maximize heat exchange between the diphasic ducts and the radiator's body. For instance, they may extend parallel to the radiative surface, and in different directions from the heat exchange device.

[0065] According to a first non-limiting example shown in FIG. **2a**, the heat exchange device may be located at a position neighboring an edge of the radiator, and the diphasic ducts **13** may extend from the heat exchange device **30** in a comb-like manner, where each second section **136** of a diphasic duct extending from the heat exchange device **30** optionally comprises a portion **137** extending from the heat exchange device, parallel to said edge, and a portion **138** perpendicular to said edge and extending towards opposite edge of the radiator.

[0066] According to another non-limiting example shown in FIG. **2b**, the heat exchange device may be located at a center of the radiator, and the diphasic ducts may extend in all directions around the heat exchange device.

[0067] In embodiments, for instance when the heat exchange device and the diphasic ducts are integrated within the radiator's body, the second sections of the diphasic ducts extending away from the heat exchange device may be arranged in a plurality of parallel planes, for instance a plurality of planes parallel to the radiative surface.

[0068] With reference to FIGS. **3a** to **5**, the first diphasic ducts sections **135** integrated to the casing **31** of the heat exchange device **30** may extend transversally to the direction of the internal cavity **310**, said direction being defined by the direction of an axis extending between the input port **311** by which the cooling fluid enters the cavity and the output port **312** by which the cooling fluid exits the cavity. Moreover, in order to increase the heat exchange surface between the diphasic duct sections and the internal cavity, the cavity **310** may be shaped to circulate around at least part of the circumference of each duct section **135**, for instance around at least 90° of circumference of each duct section. In embodiments, the first diphasic duct sections **135** may extend in parallel and be arranged in two parallel planes, with the diphasic duct sections of one plane being offset relative to the diphasic duct sections of the next plane, and the cavity **310** may be arranged to circulate between two adjacent planes of duct sections in order to alternatively circulate along each diphasic duct section.

[0069] With reference to FIGS. **3a** and **3b** is shown an example of a casing **31** of a heat exchange device **30** according to a first embodiment, in which the casing **31** of the heat exchange device and the first diphasic duct sections **135** integrated to this device are formed as a single piece, manufactured by additive manufacturing. Each first diphasic duct section is assembled to a corresponding second section **136** for instance by welding, brazing, or by a shape-memory fitting extending around the sections and maintaining the ends of each section in contact with one another. In order to ease assembly of two sections of a diphasic duct, the first diphasic duct sections **135** may protrude from the walls of the casing delimiting the internal cavity.

[0070] With reference to FIG. **4** is shown an example of a casing **31** according to another embodiment, in which the casing **31** comprises a plurality of open grooves **32** configured to receive each a corresponding first diphasic duct section. The open grooves may thus have the same shape as the diphasic duct section, and internal dimensions corre-

sponding to the external dimensions of a diphasic duct section. By "open groove", it is meant that the groove is open either on one extremity, in order to enable insertion of the diphasic duct section **135** longitudinally by said extremity, or on one side, in order to enable insertion of the diphasic duct section laterally. In this latter case the groove may be denoted as "laterally open". In the example shown in FIG. **4**, the open grooves **32** have a square cross section corresponding to the outer cross section of the diphasic duct sections but ducts with circular cross-section could also be integrated, and each groove is open on one side of the square cross section. According to another example not shown, the open grooves may have a semi-circular cross section, enabling insertion of diphasic duct sections of circular outer cross section. The assembly of the diphasic duct sections to the casing can be made by thermal glue, welding or brazing.

[0071] According to still another embodiment, an example of which is shown in FIG. **5**, the heat exchange device **30** comprises two casings **31**, **31'**, each comprising a plurality of laterally open grooves **32**, **32'** and the casings being assembled together with the open grooves **32** of each casing facing the open grooves **32'** of the other casing. Each laterally open groove may correspond to half the cross-section of a diphasic duct section. Accordingly, a first diphasic duct section **135** may be placed in a groove formed jointly by the facing open grooves of the assembled casings. The open grooves of the casing are also open at one extremity to enable the assembly of the first section **135** to the second section **136** of the diphasic duct.

[0072] In the example shown in FIG. **5**, this embodiment is applied to a redundant thermal regulation system, and each casing comprises one internal cavity connected to a corresponding cooling fluid circuit via an input port **311**, **311'** and an output port **312**, **312'**.

[0073] According to the second and third embodiments, the diphasic ducts **13** may be formed in one piece, with a first section **135** of each duct being inserted in a corresponding groove. Alternatively, the diphasic ducts **13** may be formed in two or more pieces, with one piece corresponding to the first section **135** that is inserted in a groove, and the other piece corresponding to the second section **136** that extends along the radiator's body **11**. In that case, the assembly of the sections may be performed by welding, brazing, or by a shape-memory alloy fitting.

LIST OF THE NUMERICAL REFERENCES

[0074]	R: Radiator (prior art)
[0075]	L: Cooling line (prior art)
[0076]	C: Heat-producing component
[0077]	S: Spacecraft
[0078]	1: System for thermal regulation of the spacecraft
[0079]	10: Radiator
[0080]	11: Radiator's body
[0081]	12: Radiative surface
[0082]	13: Diphasic ducts
[0083]	130: Internal cavity of a diphasic duct
[0084]	131: vapor canal
[0085]	132: capillary structure
[0086]	135: first diphasic duct section
[0087]	136: second diphasic duct section
[0088]	137: diphasic duct portion parallel to a radiator's edge,

- [0089] 138: diphasic duct portion perpendicular to a radiator's edge,
- [0090] 20: fluid circuit
- [0091] 21: pump
- [0092] 30: Heat exchange device
- [0093] 31: Casing of the heat exchange device
- [0094] 310: internal cavity of the casing
- [0095] 311: input port
- [0096] 312: output port
- [0097] 313: internal fins of the cavity
- [0098] 32: open groove

1. A system for thermal regulation of a spacecraft, comprising:

- a hot source interface,
- a radiator having a thermally conductive body comprising at least one radiative surface,

two separate single-phase cooling fluid circuits arranged in or on said hot source interface, each single-phase cooling circuit comprising a pump for activating the circulation of the single-phase cooling fluid,

the system further comprising a heat exchange device arranged in or on the body of the radiator, the heat exchange device comprising a casing comprising at least two internal cavities each having input and output ports for separately connecting each of said single-phase cooling fluid circuits to the heat exchange device,

and wherein the heat exchange device comprises a plurality of thermal interfaces with a plurality of diphasic ducts, the diphasic ducts being separate from each other and separate from the single-phase cooling fluid circuits, the diphasic ducts being arranged around the heat exchange device, each diphasic duct extending at least from a first section of said diphasic duct to a second section of said diphasic duct, said first section being arranged on one of said thermal interfaces of the heat exchange device and said second section of said diphasic duct being arranged in or on said body of said radiator, the second sections of the diphasic ducts extending around the heat exchange device.

2. The system according to claim 1, wherein the first section of each diphasic duct extends along a direction transverse to the direction of said single-phase cooling fluid circuit in the internal cavities and the internal cavities are shaped such that the cooling fluid circulating within the cavities circulates around at least part of the circumference of each duct section.

3. The system according to claim 1, wherein the first sections of the diphasic ducts comprise at least two superposed layers of first duct sections, wherein the first duct sections of a layer are offset relative to the duct sections of an adjacent layer, and the internal cavities circulate between the first duct sections of two adjacent layers.

4. The system according to claim 1, wherein the first diphasic duct sections extend parallel to each other, and the second duct sections extend in different directions in a plane parallel to the radiative surface.

5. A system for thermal regulation of a spacecraft according to claim 1, wherein each of said internal cavities comprises an internal lattice structure disposed transversally to an internal circuit joining said input and output ports and linked to said thermal interfaces.

6. The system according to claim 5, wherein the internal cavities is formed by walls of a thermally conductive material, and the internal lattice is formed of a thermally conductive material.

7. The system according to claim 1, wherein the first diphasic duct section of each diphasic duct forms an end of the diphasic duct.

8. The system according to claim 1, wherein the casing comprises the cavities and the first diphasic duct sections is formed as a single piece manufactured by additive manufacturing, and each first duct section is assembled to a second duct section extending from the casing.

9. The system according to claim 1, wherein each first diphasic duct section protrudes from a wall of the casing delimiting the internal cavities, and is assembled to a second diphasic duct section in order to form a respective diphasic duct, said assembly being achieved by welding, brazing, or by a shape-memory fitting.

10. The system according to claim 1, wherein the casing comprises a plurality of open grooves configured to receive a corresponding first diphasic duct section.

11. The system according to claim 9, wherein each first diphasic duct section is inserted in a corresponding open groove and assembled to it by thermal glue, welding or brazing.

12. The system according to claim 1, wherein each first diphasic duct section has the same thermal exchange surface with both internal cavities.

13. The system according to claim 1, comprising two casings each comprising one of the internal cavities, each casing comprising a plurality of open grooves configured each to receive a corresponding first diphasic duct section, and the two casings are assembled together with the open grooves of a casing facing the open grooves of the other casing.

14. The system according to claim 1, wherein each diphasic duct comprises at least one internal canal for vapor circulation and a capillary structure for liquid circulation.

15. A spacecraft comprising at least one heat-producing component and a system for thermal regulation according to claim 1.

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